





- Pletronics PE96/PE98 Series is a quartz crystal controlled precision square wave generator with an PECL output.
- Solder pad compatible legacy PECL oscillator solutions.
- FR4 base using the PE93 or PE99 5x7 mm ceramic packaged SMD device.
- Tape and Reel packaging is available.

- 10.9 to 1,175 MHZ
- Enable/Disable Function: PE98 on pad 2 PE96 on pad 1
- Low Jitter

This series, PE96 and PE98, is not recommended for new designs. Use PE93 or PE99 series for new designs .

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.40 grams Moisture Sensitivity Level: 1 As defined in J-STD-020C Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V _{cc} + 0.5V
Vo Output Voltage	-0.5V to V _{cc} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 40 to 80°C/Watt depending on the solder pads, ground plane and construction of the PCB.



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Part Number:

PE9 <i>x</i>	45	D	E	v	-125.0M	-XX	
							Packaging code or blank T250 = 250 per Tape and Reel T500 = 500 per Tape and Reel T1K = 1000 per Tape and Reel
							Frequency in MHZ
							Supply Voltage V _{cc} V = $3.3V \pm 10\%$
							Temperature Range blank = -10 to $+70^{\circ}$ C C = -20 to $+70^{\circ}$ C E = -40 to $+85^{\circ}$ C
							Series Model
							Frequency Stability 45 = ± 50 ppm 44 = ± 25 ppm 20 = ± 20 ppm
							Series Model (x is 6 or 8)

Part Marking:

PLE	PE9x
FF.F	FF M
• YN	1DXX

Marking Legend:

PLE = Pletronics	X = 6 or 8
FF.FFFM = Freque	ency in MHZ
YMD = Date of Manu	facture (year-month-day)
All other marking is in	ternal factory codes

Code	s for	Date	Code	YMD)													
Code	0	1	2	3	4	Code	Α	В	С	D	Ε	F	G	Н	J	K	L	М
Year	2010	2011	2012	2013	2014	Month	ו JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
C	Code		1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F	G
	Davis		4	0	0	4	~	0	7	0	0	40	4.4	40	40	4.4	45	40

Code	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F	G
Day	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Code	Н	J	κ	L	М	Ν	Р	R	Т	U	V	W	Х	Y	Ζ	



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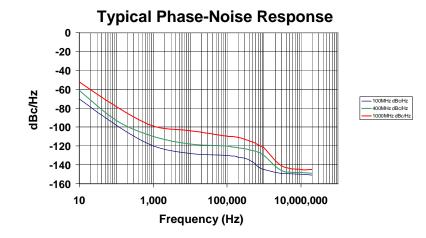
Electrical Specification for $3.30V \pm 10\%$ over the specified temperature range and the frequency range of 10.9 MHZ to 766 MHZ and 876 MHZ to 1,175MHz

Item	Min	Max	Unit	Condition			
Frequency Accuracy "45"	-50	+50	ppm	For all supply voltages, load changes, aging for 1			
"44"	-25 +25			year, shock, vibration and temperatures			
" <mark>20</mark> "	-20 +20						
Output Waveform		PECL / E	ECL				
Output High Level	2.12	2.49	volts	Referenced to Ground, V_{cc} = 3.3 V			
	0.82	1.19	volts	Referenced to termination voltage, V_{CC} = 3.3 V			
	-1.18	-0.81	volts	Referenced to Vcc, V_{cc} = 3.3 V			
Output Low Level	1.83	1.99	volts	Referenced to Ground, V_{cc} = 3.3 V			
	0.53	0.69	volts	Referenced to termination voltage, V_{cc} = 3.3 V			
	-1.47	-1.31	volts	Referenced to Vcc, V_{cc} = 3.3 V			
Output Symmetry	47	53	%	at 50% point of V_{cc} (See load circuit)			
Jitter	-	0.6	pS RMS	12 KHz to 20 MHZ from the output frequency			
	-	2.8	pS RMS	10 Hz to 20 MHZ from the output frequency			
Output T_{RISE} and T_{FALL}	100	300	pS	Vth is 20% and 80% of waveform			
V_{cc} Supply Current (I _{cc})	-	90	mA				
Enable/Disable Internal Pull-up	50	-	Kohm	to V _{cc}			
V disable	-	0.8	volts	Referenced to pad 3			
V enable	2.00	-	volts	Referenced to pad 3			
Output leakage $V_{OUT} = V_{CC}$	-50	+50	uA	Pad 1 low, device disabled			
$V_{OUT} = 0V$	-50	+50	uA				
Enable time	-	10	nS	Time for output to reach a logic state			
Disable time	-	10	nS	Time for output to reach a high Z state			
Start up time	-	5	mS	Time for output to reach specified frequency			
Operating Temperature Range	-10	+70	°C	Standard Temperature Range			
	- 20	+70	°C	Extended Temperature Range "C" Option			
	- 40	+85	°C	Extended Temperature Range "E" Option			
Storage Temperature Range	-55	+125	°C				

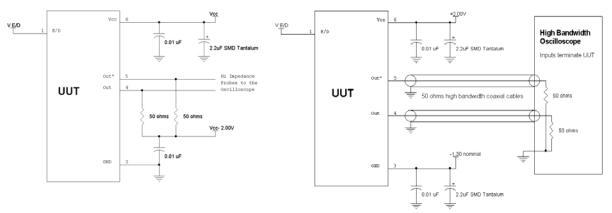
Specifications with E/D open circuit or connected to V_{cc}

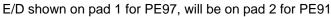


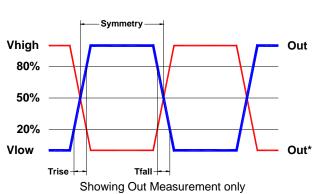
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Load Circuit











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Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A

ESD Rating

Model	Minimum Voltage	Conditions
Human Body Model	1500	MIL-STD-883 Method 3115
Charged Device Model	1000	JESD 22-C101

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII (The part number will show as PE96xx or PE98xx)

P/N:	PE9944DV-31	PLETRONICS
Custo	mer P/N:	
Qty:	12345	
ety.	1000	A-BT

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant 2nd LvL Interconnect Category=e4 Max Safe Temp=245C for 10s 2X Max

Layout and application information

For Optimum Jitter Performance, Pletronics recommends:

- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.

As much ground plane and thermal paths that can be realized under and to the side of the part is desired.

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Mechanical:

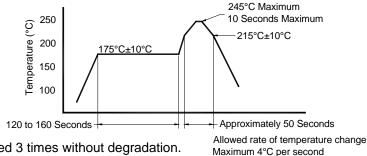
		<u>→</u>	Inches	mm
		N B	0.356 <u>+</u> 0.005	9.04 <u>+</u> 0.13
		ω K C	0.126 <u>+</u> 0.005	3.21 <u>+</u> 0.13
		J D	0.324 <u>+</u> 0.005	8.23 <u>+</u> 0.13
	┝╾────┤ ┝╾╼┼ H ───┤	F ¹ F ¹	0.050	1.27
	FR4 PCB Base: Solder masked	G ¹	0.040	1.02
Label: laser marked lettering	All via holes tented on botto	m H ¹	0.059	1.50
	Copper Clad 670 µinch (17 Nickel plated 118 µinch (3 µ	µm) l1	0.020	0.51
	Gold plated 0.8 µinch (0.02 Typical thicknesses		0.040	1.02
	Pin 3 Ground plane is typical	K ¹	0.100	2.54
	Not to scale	L ¹	0.062	1.57

PE98 Pad	PE96 Pad	Function	Note		
2	1 Output Enable/Disable		When this pad is not connected the oscillator shall operate. This is not a recommended condition!!!!!! When this pad is <0.80 volts, the output will be inhibited (High impedance state) Recommend connecting this pad to V_{cc} if the oscillator is to be always on.		
1	2	No function	Recommend connecting this pad to ground. The is internal connection.		
3	3 Ground (GND)				
2	4 Output 5 Output*		Both outputs must be terminated and biased for proper operation. The ideal termination is 50 ohms connected to 2.0V below the Supply Voltage.		
Ę			The outputs become a High Z when disabled and the voltage level is determined by the termination circuitry.		
6	6	Supply Voltage (V _{cc})	Recommend connecting appropriate power supply bypass capacitors as close as possible.		



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Reflow Cycle (typical for lead free processing)



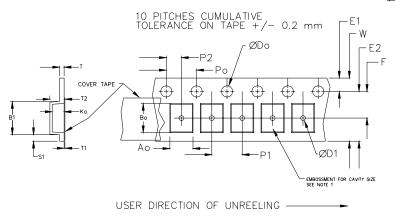
The part may be reflowed 3 times without degradation.

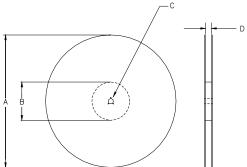
Tape and Reel: available for quantities of 250 to 1000 per reel

Constant Dimensions Table 1								
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max
8mm		1.0			2.0			
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05			
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1
24mm		1.5			<u>+</u> 0.1			

Variable Dimensions Table 2							
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko
24 mm	12.1	14.25	7.5 <u>+</u> 0.1	16.0 <u>+</u> 0.1	8.0	16.3	Note 1

Note 1: Embossed cavity to conform to EIA-481-B Dimensions in mm





		REE			
А	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
в	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13	width		
D	mm			24.4 +2.0 -0.0	24.0

Reel dimensions may vary from the above

Not to scale